



921 MHz-960 MHz SiFET RF Integrated Power Amplifier

The MHVIC910HNR2 integrated circuit is designed for GSM base stations, uses Freescale's newest High Voltage (26 Volts) LDMOS IC technology, and contains a three-stage amplifier. Target applications include macrocell (driver function) and microcell base stations (final stage). The device is in a PFP-16 Power Flat Pack package which gives excellent thermal performances through a solderable backside contact.

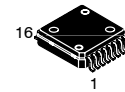
- Typical GSM Performance: $V_{DD} = 26$ Volts, $I_{DQ} = 150$ mA, $P_{out} = 10$ Watts, Full Frequency Band (921 - 960 MHz)
 Power Gain — 39 dB (Typ)
 Power Added Efficiency — 48% (Typ)
- Capable of Handling 10:1 VSWR, @ 26 Vdc, 945 MHz, 10 Watts CW Output Power
- Stable into a 10:1 VSWR. All Spurs Below -60 dBc @ 0 to 40 dBm CW P_{out} .

Features

- On-Chip Matching (50 Ohm Input, DC Blocked, >5 Ohm Output)
- Integrated ESD Protection
- Usable Frequency Range — 921 to 960 MHz
- RoHS Compliant
- In Tape and Reel. R2 Suffix = 1,500 Units per 16 mm, 13 inch Reel.

MHVIC910HNR2

**960 MHz, 10 W, 26 V
 GSM CELLULAR
 RF LDMOS INTEGRATED CIRCUIT**



**CASE 978-03
 PFP-16**

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain Supply Voltage	V_{DD}	28	Vdc
Gate Supply Voltage	V_{GS}	6	Vdc
RF Input Power	P_{in}	5	dBm
Case Operating Temperature	T_C	- 30 to + 85	°C
Storage Temperature Range	T_{stg}	- 65 to + 150	°C
Operating Channel Temperature	T_{ch}	150	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.9	°C/W

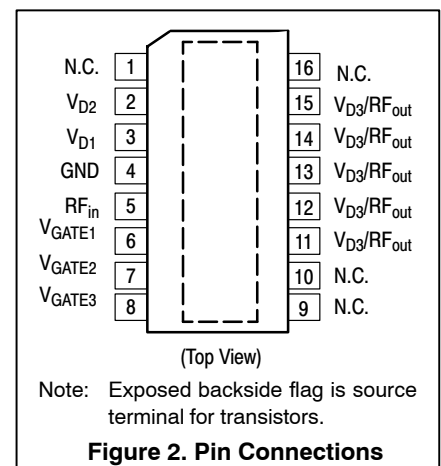
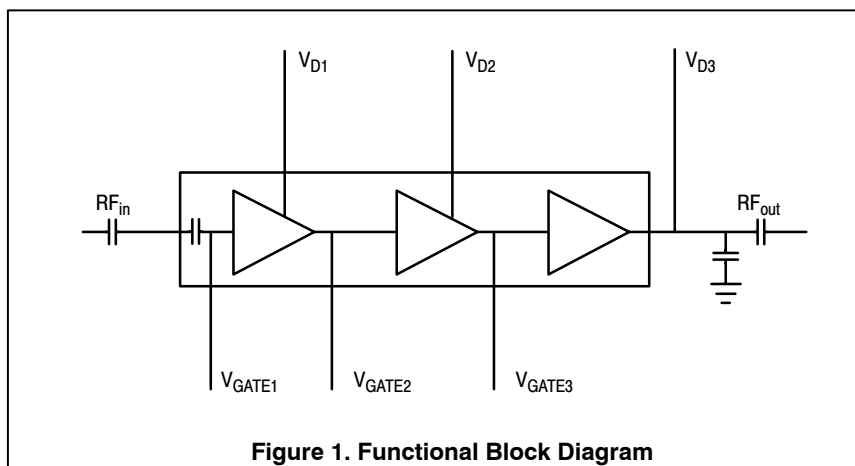


Table 3. ESD Protection Characteristics

Test Conditions	Class
Human Body Model	0 (Minimum)
Machine Model	M2 (Minimum)

Table 4. Moisture Sensitivity Level

Test Methodology	Rating	Package Peak Temperature	Unit
Per JESD 22-A113, IPC/JEDEC J-STD-020	3	260	°C

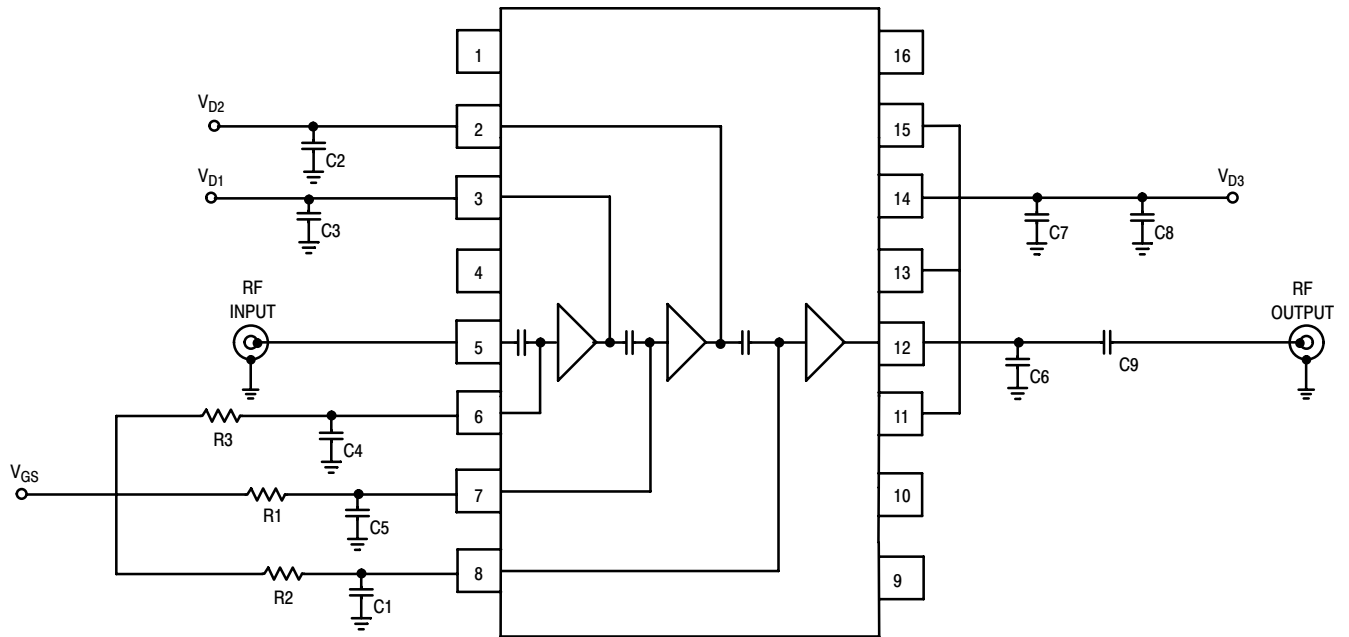
Table 5. Recommended Operating Ranges

Parameter	Symbol	Value	Unit
Drain Supply Voltage	V _{DD}	26	Vdc
3rd Stage Quiescent Current	I _{DQ3}	150	mA
2nd Stage Quiescent Current	I _{DQ2}	50	mA
1st Stage Quiescent Current	I _{DQ1}	25	mA

Table 6. Electrical Characteristics (T_A = 25°C matched to a 50 Ω system, unless otherwise noted)

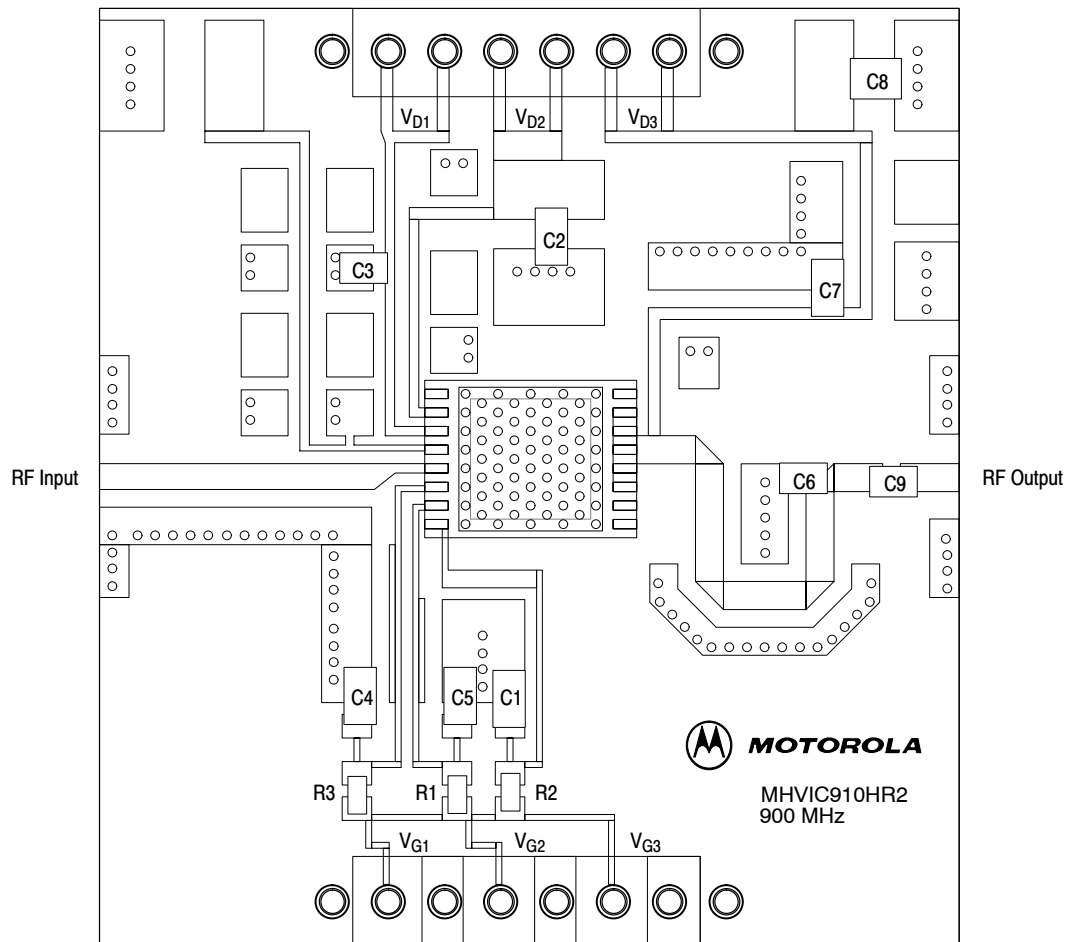
V_{DD} = 26 V, V_{GS} set for I_{DQ3} = 150 mA, frequency range 921 - 960 MHz

Characteristic	Symbol	Min	Typ	Max	Unit
Frequency Range	f _{RF}	921	—	960	MHz
Output Power @ 1 dB Compression Point	P @ 1dB	39	40	—	dBm
Power Gain @ P1dB	G @ 1dB	38	39	—	dB
Power Added Efficiency @ 1 dB Compression Point	PAE @ 1dB	43	48	—	%
Input Return Loss @ P1dB	IRL @ 1dB	—	-15	-10	dB
Gain Flatness @ 40 dBm	G _F	—	.5	—	dB
Variation (T _C = -30 to +85°C @ 40 dBm)	G _V	—	5	—	dB



C1, C2, C3, C4, C5, C8	1 μ F Surface Mount Chip Capacitors	J1, J2	Header (Break-away), HDR2X10STIMCSAFU
C6	4.7 pF AVX Chip Capacitor, ACCU-P (08051J4R7BBT)	J3, J4	SMA Connector 2052-1618-02 (Threaded)
C7	47 pF AVX Chip Capacitor, ACCU-P (08055K470JBTTTR)	R1, R2, R3	100 Ω Chip Resistors (0402)
C9	33 pF AVX Chip Capacitor, ACCU-P (08053J330JBT)	PCB	Rogers 04350, 20 mils

Figure 3. 921-960 MHz Demo Board Schematic



Freescale has begun the transition of marking Printed Circuit Boards (PCBs) with the Freescale Semiconductor signature/logo. PCBs may have either Motorola or Freescale markings during the transition period. These changes will have no impact on form, fit or function of the current product.

Figure 4. 921 -960 MHz Demo Board Component Layout

TYPICAL CHARACTERISTICS

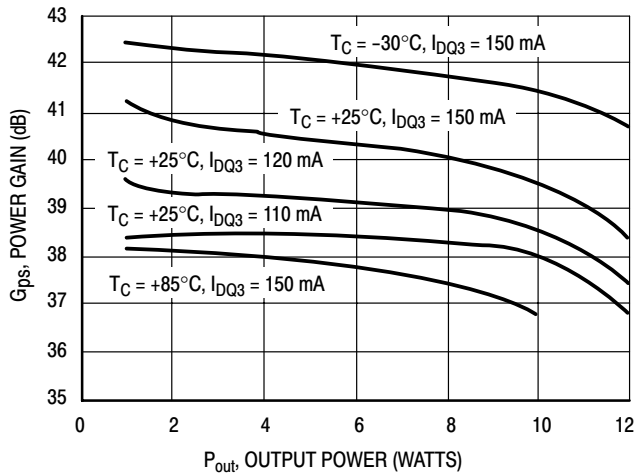


Figure 5. Power Gain versus Output Power

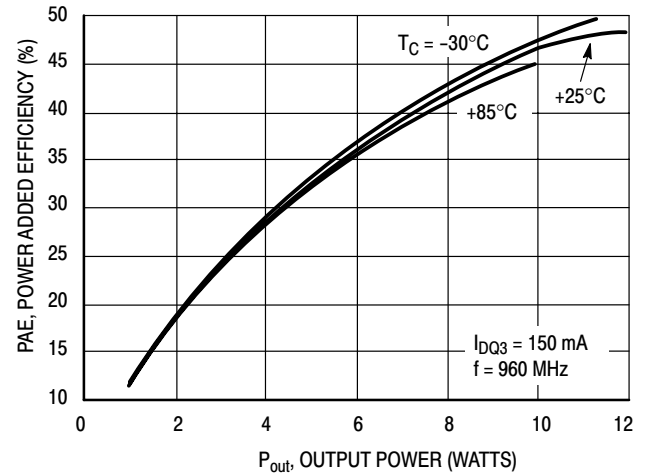


Figure 6. Power Added Efficiency versus Output Power

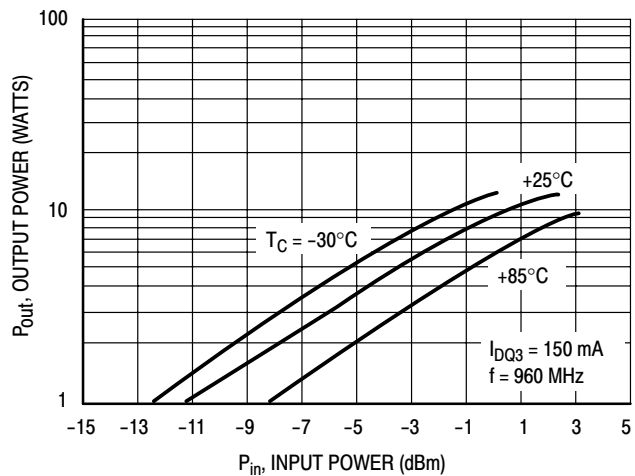
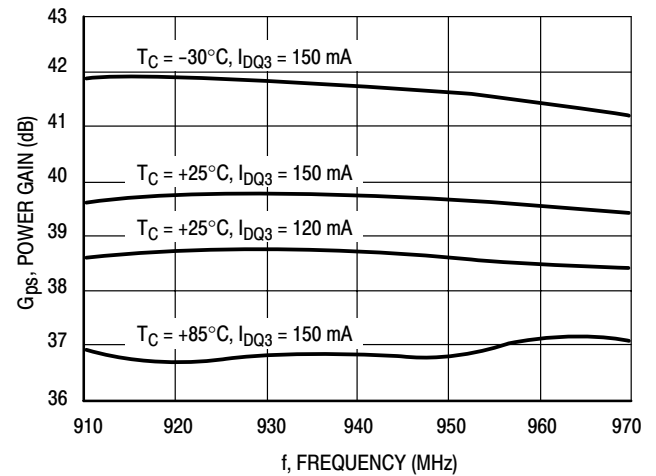
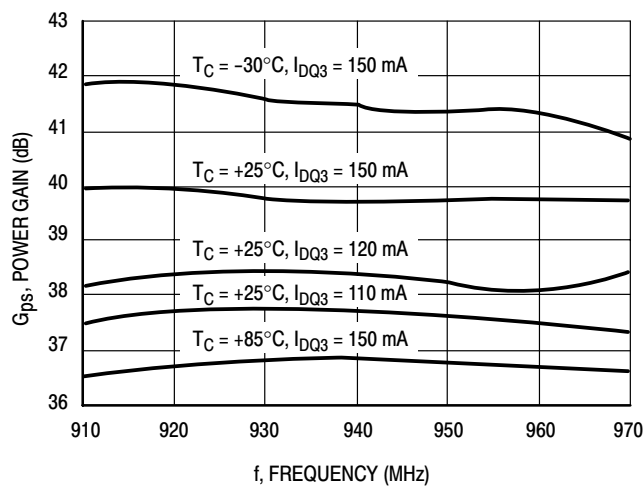


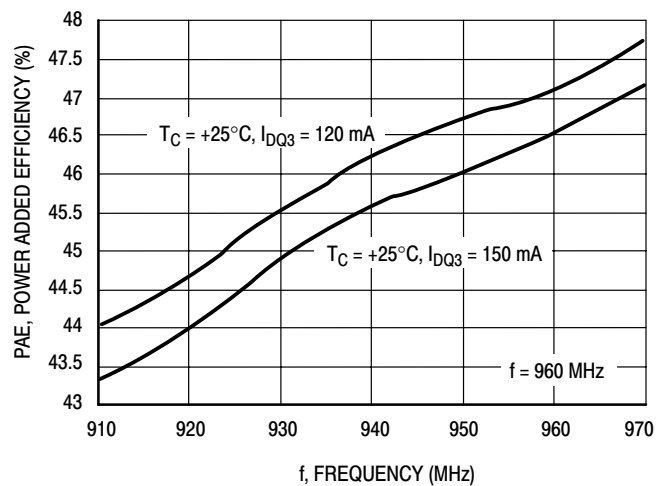
Figure 7. Output Power versus Input Power



**Figure 8. Power Gain versus Frequency
P_{out} = 10 W**



**Figure 9. Power Gain versus Frequency
P_{out} = P1dB**



**Figure 10. Power Added Efficiency versus Frequency
P_{out} = 10 W**

TYPICAL CHARACTERISTICS

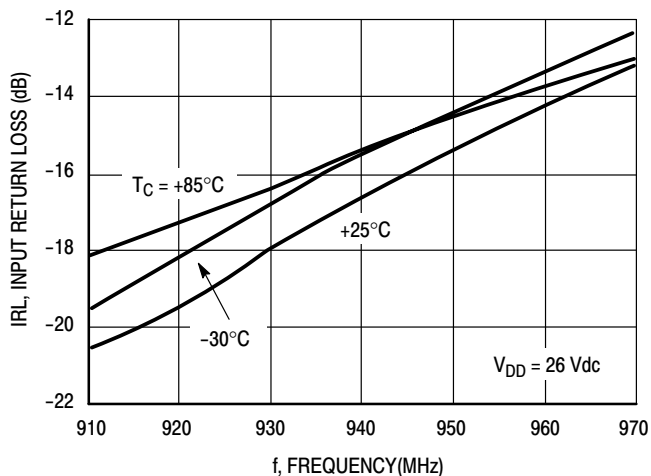


Figure 11. Input Return Loss versus Frequency
 $P_{out} = 10\text{ W}$

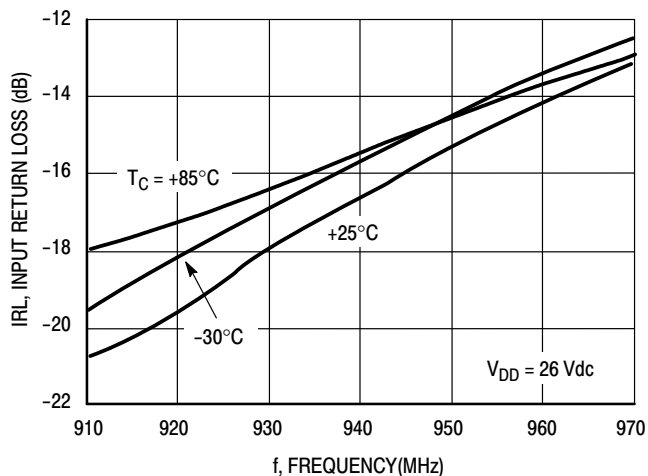


Figure 12. Input Return Loss versus Frequency
 $P_{out} = P_{1dB}$

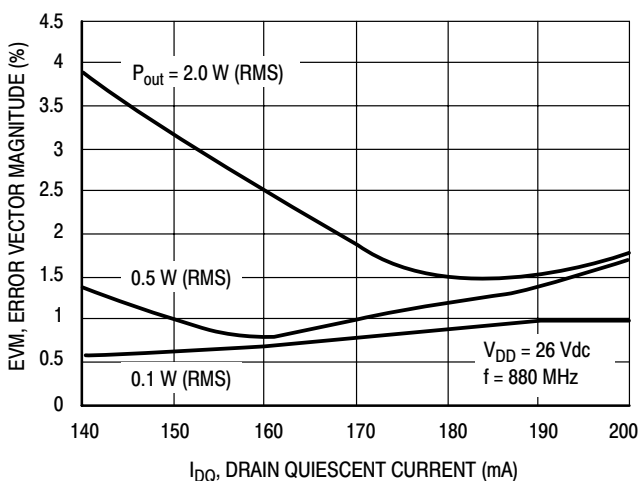


Figure 13. Error Vector Magnitude versus I_{DQ} Total

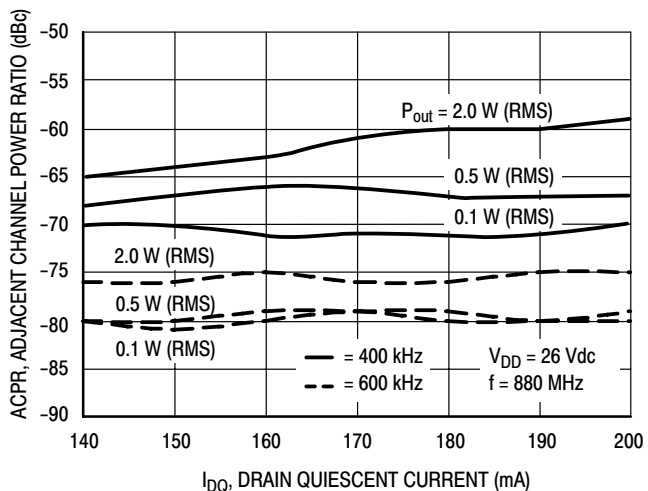


Figure 14. Adjacent Channel Power Ratio versus I_{DQ} Total

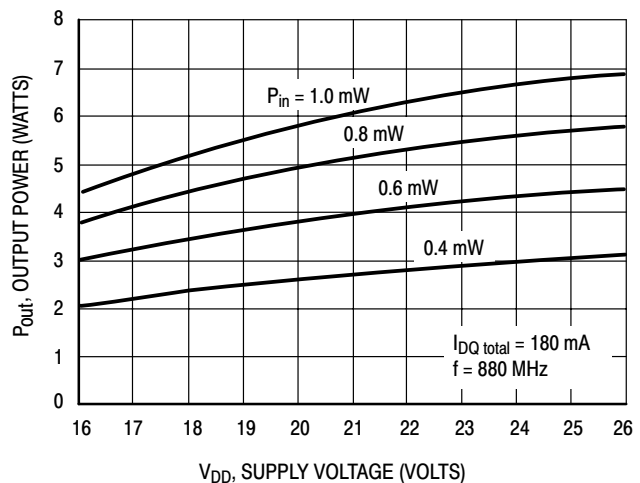


Figure 15. Output Power versus Supply Voltage

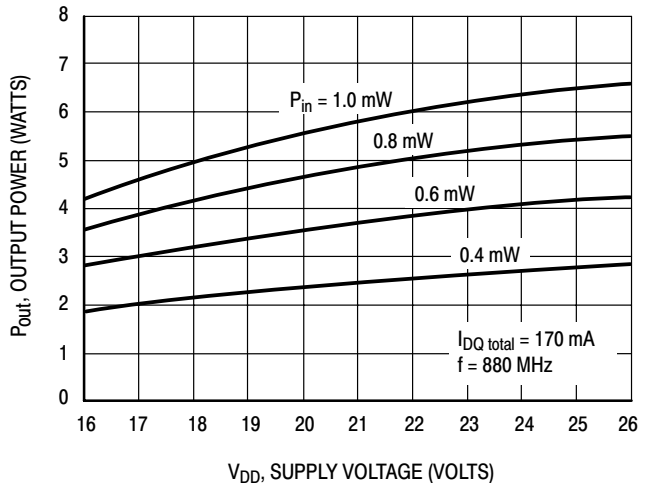


Figure 16. Output Power versus Supply Voltage

TYPICAL CHARACTERISTICS

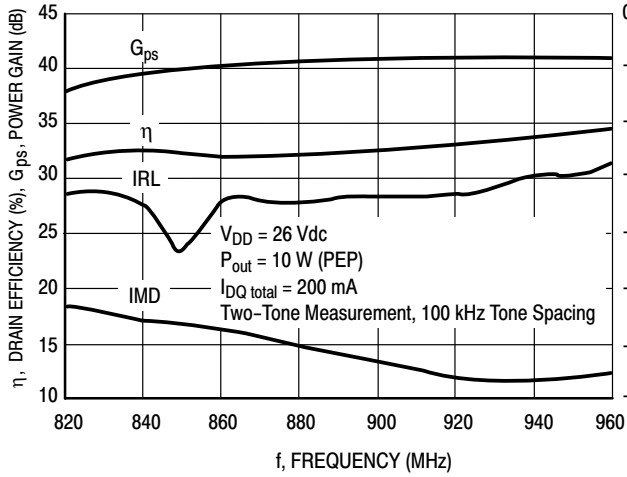


Figure 17. Two-Tone Broadband Performance

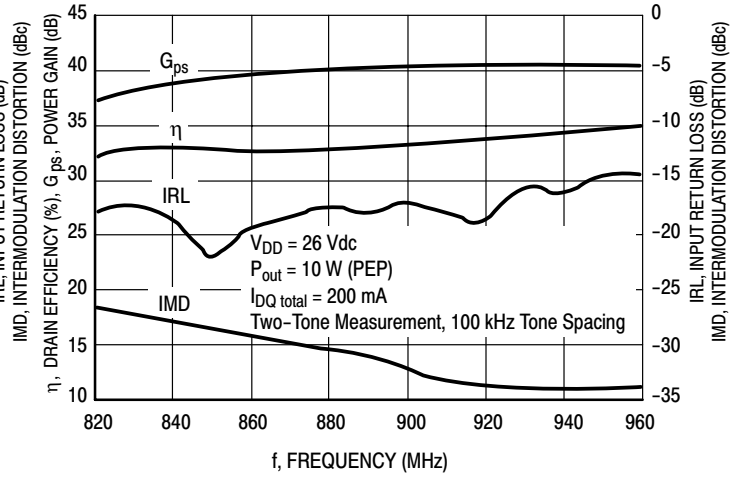


Figure 18. Two-Tone Broadband Performance

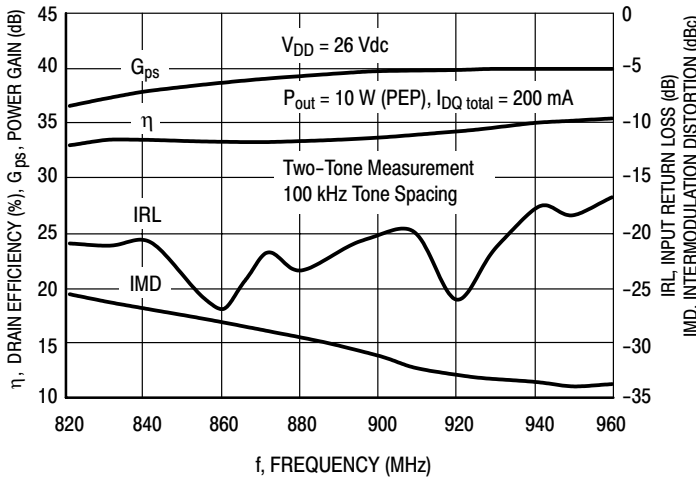


Figure 19. Two-Tone Broadband Performance

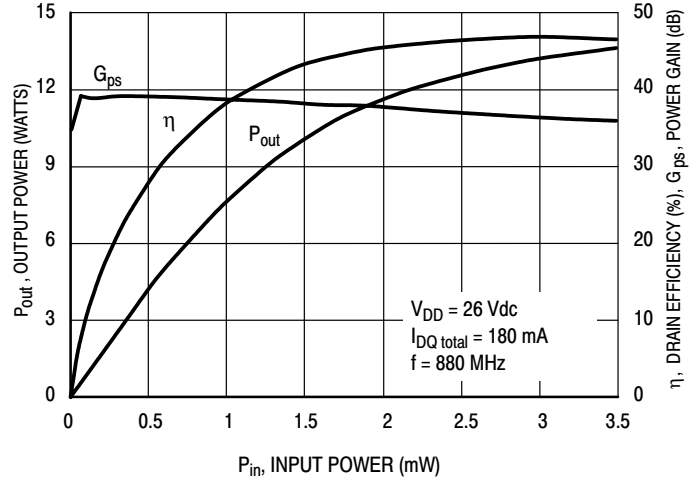


Figure 20. CW Performance @ 880 MHz

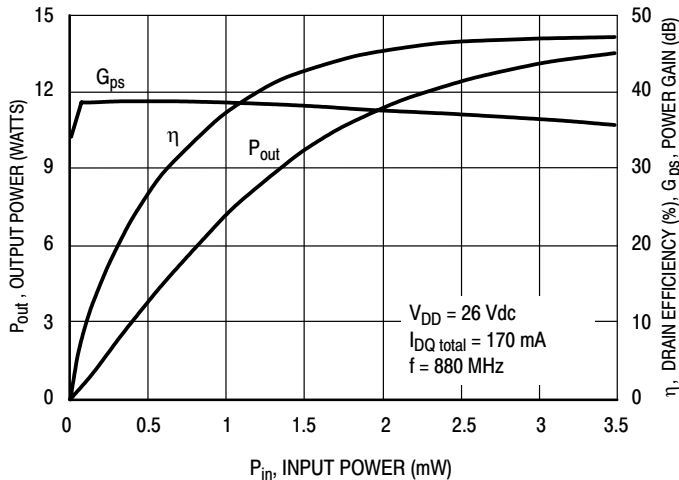


Figure 21. CW Performance @ 880 MHz

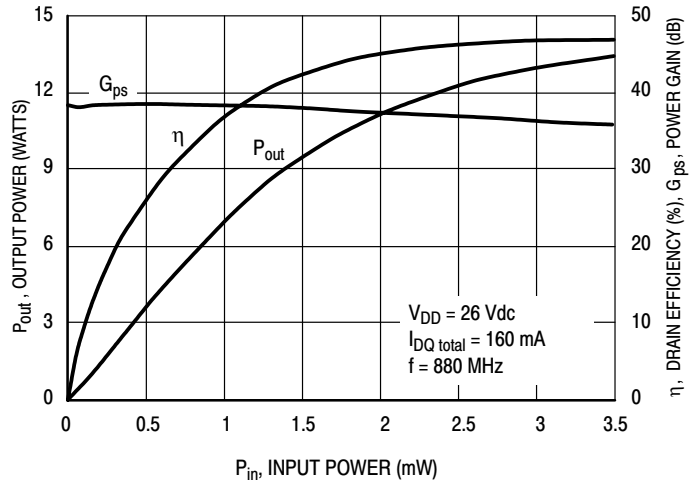


Figure 22. CW Performance @ 880 MHz

TYPICAL CHARACTERISTICS

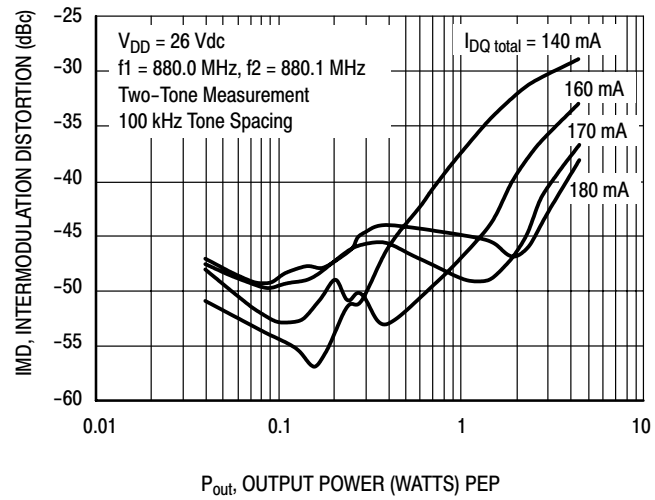


Figure 23. Intermodulation Distortion versus Output Power

$V_{DD} = 26\text{ V}$, $I_{DQ} = 225\text{ mA}$, $P_{out} = 40\text{ dBm}$

f MHz	Z_{load} Ω
900	$7.81 + j4.61$
920	$7.27 + j4.90$
940	$6.77 + j5.23$
960	$6.31 + j5.59$
980	$5.90 + j5.96$
1000	$5.53 + j6.36$

Z_{load} = Test circuit impedance as measured from drain to ground.

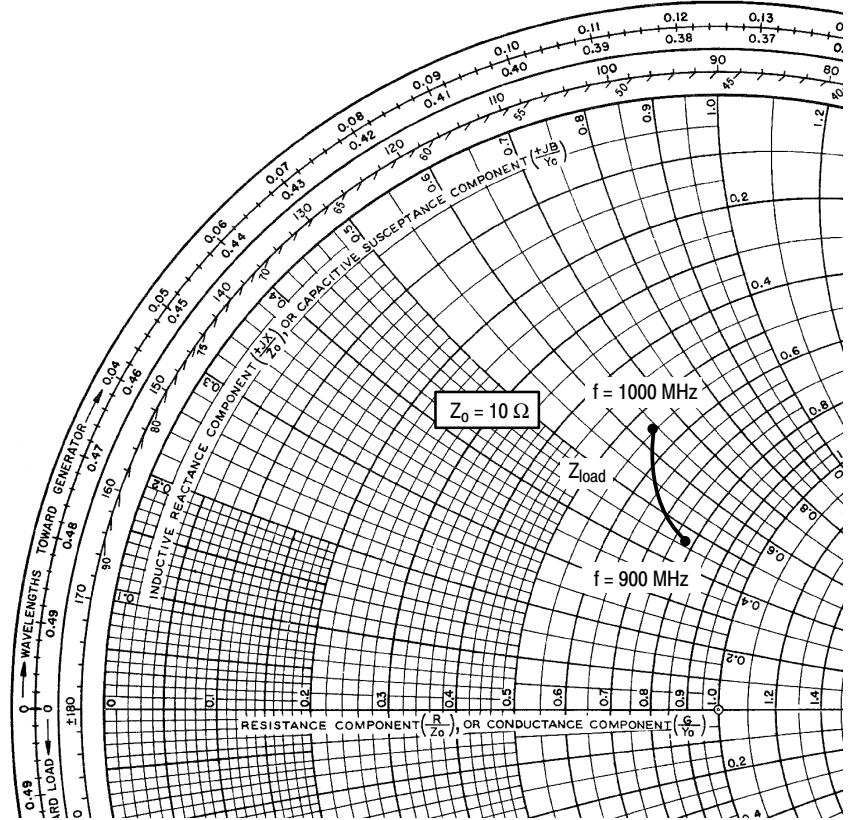
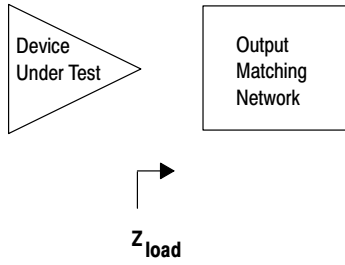
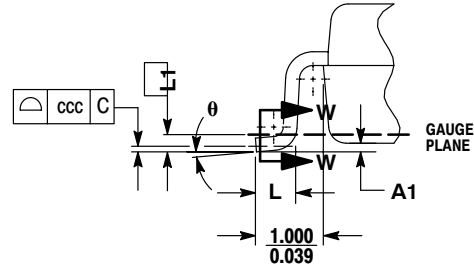
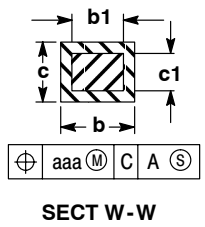
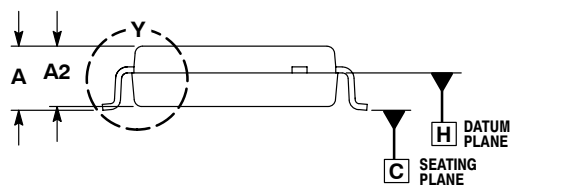
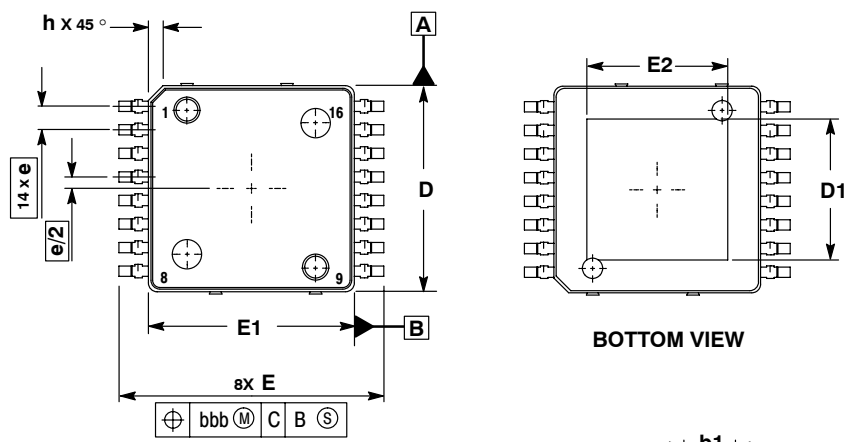


Figure 24. Series Equivalent Load Impedance

NOTES

PACKAGE DIMENSIONS



- NOTES:
1. CONTROLLING DIMENSION: MILLIMETER.
 2. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
 3. DATUM PLANE -H- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.250 PER SIDE. DIMENSIONS D AND E1 DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -H-.
 5. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION IS 0.127 TOTAL IN EXCESS OF THE b DIMENSION AT MAXIMUM MATERIAL CONDITION.
 6. DATUMS -A- AND -B- TO BE DETERMINED AT DATUM PLANE -H-.

DIM	MILLIMETERS	
	MIN	MAX
A	2.000	2.300
A1	0.025	0.100
A2	1.950	2.100
D	6.950	7.100
D1	4.372	5.180
E	8.850	9.150
E1	6.950	7.100
E2	4.372	5.180
L	0.466	0.720
L1	0.250 BSC	
b	0.300	0.432
b1	0.300	0.375
c	0.180	0.279
c1	0.180	0.230
e	0.800 BSC	
h	---	0.600
θ	0°	7°
aaa	0.200	
bbb	0.200	
ccc	0.100	

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